















SN74AUP1G80

SCES593F - JULY 2004-REVISED JULY 2017

## SN74AUP1G80 Low-Power Single Positive-Edge-Triggered D-Type Flip-Flop

### **Features**

- Latch-Up Performance Exceeds 100 mA Per JESD 78. Class II
- ESD Performance Tested Per JESD 22
  - 2000-V Human-Body Model (A114-B, Class II)
  - 1000-V Charged-Device Model (C101)
- Available in the Texas Instruments NanoStar™ Package
- Low Static-Power Consumption  $(I_{CC} = 0.9 \mu A Maximum)$
- Low Dynamic-Power Consumption  $(C_{pd} = 4.3 \text{ pF Typical at } 3.3 \text{ V})$
- Low Input Capacitance (C<sub>i</sub> = 1.5 pF Typical)
- Low Noise Overshoot and Undershoot <10% of
- I<sub>off</sub> Supports Partial-Power-Down Mode Operation
- Schmitt-Trigger Action Allows Slow Input Transition and Better Switching Noise Immunity at the Input  $(V_{hys} = 250 \text{ mV Typical at } 3.3 \text{ V})$ 
  - Wide Operating V<sub>CC</sub> Range of 0.8 V to 3.6 V
- Optimized for 3.3-V Operation
- 3.6-V I/O Tolerant to Support Mixed-Mode Signal
- $t_{pd} = 4.4$  ns Maximum at 3.3 V
- Suitable for Point-to-Point Applications

## **Applications**

- Home Automation
- **Factory Automation**
- Test and Measurement
- **Enterprise Switching**
- Telecom Infrastructure
- Personal Electronics
- White Goods

## 3 Description

The AUP family is TI's premier solution to the industry's low-power needs in battery-powered portable applications. This family assures a low staticand dynamic-power consumption across the entire V<sub>CC</sub> range of 0.8 V to 3.6 V, resulting in increased battery life (see AUP - The Lowest-Power Family). This product also maintains excellent signal integrity (see Excellent Signal Integrity).

This is a single positive-edge-triggered D-type flipflop. When data at the data (D) input meets the setup time requirement, the data is transferred to the Q output on the positive-going edge of the clock pulse. Clock triggering occurs at a voltage level and is not directly related to the rise time of the clock pulse. Following the hold-time interval, data at the D input can be changed without affecting the levels at the outputs.

package NanoStar™ technology is a breakthrough in IC packaging concepts, using the die as the package.

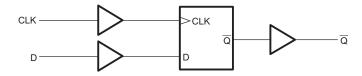
This device is fully specified for partial-power-down applications using Ioff. The Ioff circuitry disables the outputs when the device is powered down. This inhibits current backflow into the device which prevents damage to the device.

## Device Information<sup>(1)</sup>

| PART NUMBER    | PACKAGE    | BODY SIZE (NOM)   |
|----------------|------------|-------------------|
| SN74AUP1G80DBV | SOT-23 (5) | 1.60 mm × 2.90 mm |
| SN74AUP1G80DCK | SC70 (5)   | 1.25 mm × 2.00 mm |
| SN74AUP1G80DRY | SON (6)    | 1.00 mm × 1.45 mm |
| SN74AUP1G80DSF | SON (6)    | 1.00 mm × 1.00 mm |
| SN74AUP1G80YFP | DSBGA (6)  | 0.76 mm × 1.16 mm |
| SN74AUP1G80YZP | DSBGA (5)  | 0.89 mm × 1.39 mm |
| SN74AUP1G80DPW | X2SON (5)  | 0.80 mm × 0.80 mm |

(1) For all available packages, see the orderable addendum at the end of the data sheet.

## Logic Diagram (Positive Logic)





## **Table of Contents**

| 1 | Features 1   | 7.2 Enable and Disable Times                 | 13         |
|---|--|--|------------|
| 2 | Applications 1   | 8 Detailed Description                       | 14         |
| 3 | Description 1  | 8.1 Overview                                 | 14         |
| 4 | Revision History2  | 8.2 Functional Block Diagram                 | 14         |
| 5 | Pin Configuration and Functions  | 8.3 Feature Description                      | 14         |
| 6 | Specifications4  | 8.4 Device Functional Modes                  | 15         |
| U | 6.1 Absolute Maximum Ratings   | 9 Application and Implementation             | 16         |
|   | 6.2 ESD Ratings  | 9.1 Application Information                  | 16         |
|   | 6.3 Recommended Operating Conditions                                   | 9.2 Typical Application                      | 16         |
|   | 6.4 Thermal Information  | 10 Power Supply Recommendations              | 17         |
|   | 6.5 Electrical Characteristics: T <sub>A</sub> = 25°C                  | 11 Layout                                    | 17         |
|   | 6.6 Electrical Characteristics: $T_A = -40^{\circ}\text{C}$ to +85°C 7 | 11.1 Layout Guidelines                       |            |
|   | 6.7 Timing Requirements  | 11.2 Layout Example                          |            |
|   | 6.8 Switching Characteristics: C <sub>1</sub> = 5 pF                   | 12 Device and Documentation Support          |            |
|   | 6.9 Switching Characteristics: C <sub>L</sub> = 10 pF9                 | 12.1 Documentation Support                   |            |
|   | 6.10 Switching Characteristics: C <sub>L</sub> = 15 pF9                | 12.2 Receiving Notification of Documentation | Updates 18 |
|   | 6.11 Switching Characteristics: C <sub>1</sub> = 30 pF 10              | 12.3 Community Resources                     | 18         |
|   | 6.12 Operating Characteristics   | 12.4 Trademarks                              | 18         |
|   | 6.13 Typical Characteristics   | 12.5 Electrostatic Discharge Caution         | 18         |
| 7 | Parameter Measurement Information 12                                   | 12.6 Glossary                                |            |
| - | 7.1 Propagation Delays, Setup and Hold Times, and                      | 13 Mechanical, Packaging, and Orderable      |            |
|   | Pulse Duration 12  | Information                                  | 18         |
|   |  |  |            |

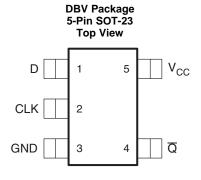
**4 Revision History**NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| <ul> <li>Added DPW (X2SON) package</li></ul> | Page   |   |
|--|--|---|
| •  | Added DPW (X2SON) package  | 1 |
| •  | table, Feature Description section, Device Functional Modes, Application and Implementation section, Power Supply Recommendations section, Layout section, Device and Documentation Support section, and Mechanical, |   |
| •  |  | 1 |
| •  | Added Junction temperature, T <sub>J</sub> in <i>Absolute Maximum Ratings</i> table  | 4 |

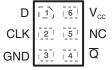
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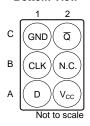
## 5 Pin Configuration and Functions

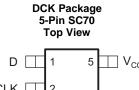


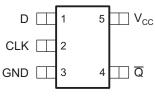




YFP Package 6-Pin DSBGA **Bottom View** 



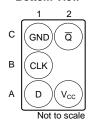








YZP Package 5-Pin DSBGA **Bottom View** 



**DPW Package** 5-Pin X2SON **Top View** 



## **Pin Functions**

| PIN             |             |          |     |     |     |     |                                     |
|-----------------|-------------|----------|-----|-----|-----|-----|-------------------------------------|
| NAME            | DBV,<br>DCK | DRY, DSF | YFP | YZP | DPW | I/O | DESCRIPTION                         |
| D               | 1           | 1        | A1  | A1  | 1   | I   | Data input                          |
| CLK             | 2           | 2        | B1  | B1  | 2   | I   | Positive-Edge-Triggered Clock input |
| GND             | 3           | 3        | C1  | C1  | 3   | _   | Ground pin                          |
| Q               | 4           | 4        | C2  | C2  | 4   | 0   | Inverted output                     |
| NC              | _           | 5        | B2  | _   | _   | _   | No Internal Connection              |
| V <sub>CC</sub> | 5           | 6        | A2  | A2  | 5   | _   | Positive Supply                     |



## **Specifications**

## 6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)(1)

|                  |   |                    | MIN  | MAX                   | UNIT |
|------------------|---|--------------------|------|-----------------------|------|
| V <sub>CC</sub>  | Supply voltage  |                    | -0.5 | 4.6                   | V    |
| VI               | Input voltage (2)   |                    |      | 4.6                   | V    |
| Vo               | Voltage range applied to any output in the high-impedance or power-off state <sup>(2)</sup> |                    |      | 4.6                   | V    |
| Vo               | Voltage range applied to any output in the high or low state (2)                            |                    |      | V <sub>CC</sub> + 0.5 | V    |
| I <sub>IK</sub>  | Input clamp current   | V <sub>I</sub> < 0 |      | -50                   | mA   |
| I <sub>OK</sub>  | Output clamp current  | V <sub>O</sub> < 0 |      | <b>-</b> 50           | mA   |
| Io               | Continuous output current   |                    |      | ±20                   | mA   |
|                  | Continuous current through V <sub>CC</sub> or GND   |                    |      | ±50                   | mA   |
| TJ               | Junction temperature  |                    |      | 150                   | °C   |
| T <sub>stg</sub> | Storage temperature   |                    | -65  | 150                   | °C   |

<sup>(1)</sup> Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

## 6.2 ESD Ratings

|                           |                         |   | VALUE | UNIT |
|---------------------------|-------------------------|---|-------|------|
| V <sub>(ESD)</sub> Electr |                         | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 (1)              | 2000  | \/   |
|                           | Electrostatic discharge | Charged-device model (CDM), per JEDEC specification JESD22-C101 (2) | 1000  | V    |

JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

## 6.3 Recommended Operating Conditions

See (1)

|                 |                               |   | MIN                    | MAX                  | UNIT |
|-----------------|-------------------------------|---|------------------------|----------------------|------|
| V <sub>CC</sub> | Supply voltage                |   | 0.8                    | 3.6                  | V    |
|                 |                               | V <sub>CC</sub> = 0.8 V                     | V <sub>CC</sub>        |                      |      |
| .,              | Lligh level input veltage     | $V_{CC} = 1.1 \text{ V to } 1.95 \text{ V}$ | 0.65 × V <sub>CC</sub> |                      | V    |
| V <sub>IH</sub> | High-level input voltage      | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$  | 1.6                    |                      | V    |
|                 |                               | $V_{CC} = 3 \text{ V to } 3.6 \text{ V}$    | 2                      |                      |      |
|                 | Low-level input voltage       | V <sub>CC</sub> = 0.8 V                     |                        | 0                    |      |
| .,              |                               | $V_{CC} = 1.1 \text{ V to } 1.95 \text{ V}$ |                        | $0.35 \times V_{CC}$ | V    |
| V <sub>IL</sub> |                               | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$  |                        | 0.7                  |      |
|                 |                               | V <sub>CC</sub> = 3 V to 3.6 V              |                        | 0.9                  |      |
| VI              | Input voltage                 |   | 0                      | 3.6                  | V    |
| Vo              | Output voltage                |   | 0                      | $V_{CC}$             | V    |
|                 |                               | V <sub>CC</sub> = 0.8 V                     |                        | -20                  | μΑ   |
|                 |                               | V <sub>CC</sub> = 1.1 V                     |                        | -1.1                 |      |
|                 | High lavel autout augrent(2)  | V <sub>CC</sub> = 1.4 V                     |                        | -1.7                 |      |
| I <sub>OH</sub> | High-level output current (2) | V <sub>CC</sub> = 1.65                      |                        | -1.9                 | mA   |
|                 |                               | V <sub>CC</sub> = 2.3 V                     |                        | -3.1                 |      |
|                 |                               | V <sub>CC</sub> = 3 V                       |                        | -4                   |      |

All unused inputs of the device must be held at V<sub>CC</sub> or GND to assure proper device operation. See *Implications of Slow or Floating* CMOS Inputs, SCBA004.

Product Folder Links: SN74AUP1G80

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The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.

JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

Defined by the signal integrity requirements and design-goal priorities.



## **Recommended Operating Conditions (continued)**

See (1)

|                 |  |                                  | MIN | MAX | UNIT |
|-----------------|--|----------------------------------|-----|-----|------|
|                 | lor I ow-level output current <sup>(2)</sup> | V <sub>CC</sub> = 0.8 V          |     | 20  | μΑ   |
| I <sub>OL</sub> |  | V <sub>CC</sub> = 1.1 V          |     | 1.1 |      |
|                 |  | V <sub>CC</sub> = 1.4 V          |     | 1.7 |      |
|                 |  | V <sub>CC</sub> = 1.65 V         |     | 1.9 | mA   |
|                 |  | V <sub>CC</sub> = 2.3 V          |     | 3.1 |      |
|                 |  | V <sub>CC</sub> = 3 V            |     | 4   |      |
| Δt/Δν           | Input transition rise or fall rate           | V <sub>CC</sub> = 0.8 V to 3.6 V |     | 200 | ns/V |
| T <sub>A</sub>  | Operating free-air temperature               |                                  | -40 | 85  | °C   |

## 6.4 Thermal Information

|                       | mermar imerme                                      | 1         |            |           |           |             |             |             |      |
|-----------------------|--|-----------|------------|-----------|-----------|-------------|-------------|-------------|------|
|                       |  |           |            |           | SN74AUP1  | G80         |             |             |      |
| TH                    | ERMAL METRIC(1)                                    | DBV (SOT) | DCK (SC70) | DRY (SON) | DSF (SON) | YFP (DSBGA) | YZP (DSBGA) | DPW (X2SON) | UNIT |
|                       |  | 5 PINS    | 5 PINS     | 6 PINS    | 6 PINS    | 6 PINS      | 5 PINS      | 5 PINS      |      |
| $R_{\theta JA}$       | Junction-to-ambient thermal resistance             | 267.2     | 284.1      | 341.1     | 377.1     | 125.4       | 146.2       | 489.2       | °C/W |
| R <sub>θJC(top)</sub> | Junction-to-case (top) thermal resistance          | 191.9     | 208.5      | 233.1     | 187.7     | 1.9         | 1.4         | 226.3       | °C/W |
| $R_{\theta JB}$       | Junction-to-board thermal resistance               | 101.1     | 103.1      | 206.7     | 236.6     | 37.2        | 39.3        | 352.9       | °C/W |
| ΨЈТ                   | Junction-to-top<br>characterization<br>parameter   | 83.0      | 76.6       | 63.4      | 29.0      | 0.5         | 0.7         | 38.2        | °C/W |
| ΨЈВ                   | Junction-to-board characterization parameter       | 100.8     | 102.3      | 206.7     | 236.3     | 37.5        | 39.8        | 352.1       | °C/W |
| R <sub>θJC(bot)</sub> | Junction-to-case<br>(bottom) thermal<br>resistance | n/a       | n/a        | n/a       | n/a       | n/a         | n/a         | 150.8       | °C/W |

<sup>(1)</sup> For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.



## 6.5 Electrical Characteristics: T<sub>A</sub> = 25°C

over recommended operating free-air temperature range,  $T_A = 25$ °C (unless otherwise noted)

| PARAMETER                     | TEST CONDITIONS   | V <sub>CC</sub> | MIN                    | TYP | MAX                   | UNIT |
|-------------------------------|---|-----------------|------------------------|-----|-----------------------|------|
|                               | I <sub>OH</sub> = -20 μA  | 0.8 V to 3.6 V  | V <sub>CC</sub> - 0.1  |     |                       |      |
|                               | $I_{OH} = -1.1 \text{ mA}$  | 1.1 V           | 0.75 × V <sub>CC</sub> |     |                       |      |
|                               | $I_{OH} = -1.7 \text{ mA}$  | 1.4 V           | 1.11                   |     |                       |      |
|                               | $I_{OH} = -1.9 \text{ mA}$  | 1.65 V          | 1.32                   |     |                       | V    |
| V <sub>OH</sub>               | $I_{OH} = -2.3 \text{ mA}$  | 227             | 2.05                   |     |                       | V    |
|                               | $I_{OH} = -3.1 \text{ mA}$  | 2.3 V           | 1.9                    |     |                       |      |
|                               | $I_{OH} = -2.7 \text{ mA}$  | 2.1/            | 2.72                   |     |                       |      |
|                               | $I_{OH} = -4 \text{ mA}$  | 3 V             | 2.6                    |     |                       |      |
|                               | I <sub>OL</sub> = 20 μA   | 0.8 V to 3.6 V  |                        |     | 0.1                   |      |
|                               | I <sub>OL</sub> = 1.1 mA  | 1.1 V           |                        |     | 0.3 × V <sub>CC</sub> |      |
|                               | I <sub>OL</sub> = 1.7 mA  | 1.4 V           |                        |     | 0.31                  |      |
| V                             | I <sub>OL</sub> = 1.9 mA  | 1.65 V          |                        |     | 0.31                  | V    |
| $V_{OL}$                      | I <sub>OL</sub> = 2.3 mA  | 0.01/           |                        |     | 0.31                  | V    |
|                               | I <sub>OL</sub> = 3.1 mA  | 2.3 V           |                        |     | 0.44                  |      |
|                               | I <sub>OL</sub> = 2.7 mA  | 2.1/            |                        |     | 0.31                  |      |
|                               | I <sub>OL</sub> = 4 mA  | 3 V             |                        |     | 0.44                  |      |
| I <sub>I</sub> D or CLK input | V <sub>I</sub> = GND to 3.6 V                                     | 0 V to 3.6 V    |                        |     | 0.1                   | μΑ   |
| I <sub>off</sub>              | $V_I$ or $V_O = 0$ V to 3.6 V                                     | 0 V             |                        |     | 0.2                   | μΑ   |
| $\Delta I_{ m off}$           | $V_I$ or $V_O = 0 V$ to 3.6 V                                     | 0 V to 0.2 V    |                        |     | 0.2                   | μA   |
| I <sub>CC</sub>               | $V_I = GND \text{ or } V_{CC} \text{ to } 3.6 \text{ V}, I_O = 0$ | 0.8 V to 3.6 V  |                        |     | 0.5                   | μΑ   |
| Δl <sub>CC</sub>              | $V_I = V_{CC} - 0.6 \text{ V},^{(1)} I_O = 0$                     | 3.3 V           |                        |     | 40                    | μΑ   |
|                               | V V or CND  | 0 V             |                        | 1.5 |                       | ~F   |
| C <sub>i</sub>                | $V_I = V_{CC}$ or GND   | 3.6 V           |                        | 1.5 |                       | pF   |
| C <sub>o</sub>                | V <sub>O</sub> = GND  | 0 V             |                        | 3   |                       | pF   |

<sup>(1)</sup> One input at  $V_{CC}$  – 0.6 V, other input at  $V_{CC}$  or GND

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## 6.6 Electrical Characteristics: $T_A = -40$ °C to +85°C

over recommended operating free-air temperature range,  $T_A = -40$ °C to +85°C (unless otherwise noted)

| PARAMETER                     | TEST CONDITIONS   | V <sub>cc</sub> | MIN                   | MAX                 | UNIT |
|-------------------------------|---|-----------------|-----------------------|---------------------|------|
|                               | I <sub>OH</sub> = -20 μA  | 0.8 V to 3.6 V  | V <sub>CC</sub> - 0.1 |                     |      |
|                               | $I_{OH} = -1.1 \text{ mA}$  | 1.1 V           | $0.7 \times V_{CC}$   |                     |      |
|                               | $I_{OH} = -1.7 \text{ mA}$  | 1.4 V           | 1.03                  |                     |      |
| W                             | $I_{OH} = -1.9 \text{ mA}$  | 1.65 V          | 1.3                   |                     | V    |
| V <sub>OH</sub>               | $I_{OH} = -2.3 \text{ mA}$  | 2.2.1/          | 1.97                  |                     | V    |
|                               | $I_{OH} = -3.1 \text{ mA}$  | 2.3 V           | 1.85                  |                     |      |
|                               | $I_{OH} = -2.7 \text{ mA}$  | 3 V             | 2.67                  |                     |      |
|                               | $I_{OH} = -4 \text{ mA}$  | 3 V             | 2.55                  |                     |      |
|                               | I <sub>OL</sub> = 20 μA   | 0.8 V to 3.6 V  |                       | 0.1                 |      |
|                               | I <sub>OL</sub> = 1.1 mA  | 1.1 V           |                       | $0.3 \times V_{CC}$ |      |
|                               | I <sub>OL</sub> = 1.7 mA  | 1.4 V           |                       | 0.37                |      |
| V                             | I <sub>OL</sub> = 1.9 mA  | 1.65 V          | 1.65 V                |                     | V    |
| $V_{OL}$                      | I <sub>OL</sub> = 2.3 mA  | 2.3 V           |                       | 0.33                | V    |
|                               | I <sub>OL</sub> = 3.1 mA  | 2.3 V           |                       | 0.45                |      |
|                               | I <sub>OL</sub> = 2.7 mA  | 3 V             |                       | 0.33                |      |
|                               | I <sub>OL</sub> = 4 mA  | 3 V             |                       | 0.45                |      |
| I <sub>I</sub> D or CLK input | $V_I = GND \text{ to } 3.6 \text{ V}$                             | 0 V to 3.6 V    |                       | 0.5                 | μA   |
| I <sub>off</sub>              | $V_I$ or $V_O = 0$ V to 3.6 V                                     | 0 V             |                       | 0.6                 | μΑ   |
| $\Delta I_{ m off}$           | $V_I$ or $V_O = 0$ V to 3.6 V                                     | 0 V to 0.2 V    |                       | 0.6                 | μΑ   |
| I <sub>cc</sub>               | $V_I = GND \text{ or } V_{CC} \text{ to } 3.6 \text{ V}, I_O = 0$ | 0.8 V to 3.6 V  |                       | 0.9                 | μΑ   |
| Δl <sub>CC</sub>              | $V_I = V_{CC} - 0.6 \text{ V},^{(1)} I_O = 0$                     | 3.3 V           |                       | 50                  | μΑ   |

<sup>(1)</sup> One input at  $V_{CC}-0.6\ V,$  other input at  $V_{CC}$  or GND

## 6.7 Timing Requirements

over recommended operating free-air temperature range,  $T_A = -40$ °C to +85°C (unless otherwise noted) (see Figure 3)

|                    |                                 | V <sub>CC</sub> | MIN | TYP <sup>(1)</sup> | MAX | UNIT   |
|--------------------|---------------------------------|-----------------|-----|--------------------|-----|--------|
|                    |                                 | 0.8 V           |     |                    | 20  |        |
|                    |                                 | 1.2 V ± 0.1 V   |     |                    | 80  |        |
| 4                  | Clock fraguency                 | 1.5 V ± 0.1 V   |     |                    | 120 | MHz    |
| f <sub>clock</sub> | Clock frequency                 | 1.8 V ± 0.15 V  |     |                    | 160 | IVITIZ |
|                    |                                 | 2.5 V ± 0.2 V   |     |                    | 220 |        |
|                    |                                 | 3.3 V ± 0.3 V   |     |                    | 260 |        |
|                    |                                 | 0.8 V           | 5.5 |                    |     |        |
|                    |                                 | 1.2 V ± 0.1 V   | 2.5 |                    |     |        |
|                    | Dulgo duration CLIV high or low | 1.5 V ± 0.1 V   | 1.5 |                    |     |        |
| t <sub>w</sub>     | Pulse duration, CLK high or low | 1.8 V ± 0.15 V  | 1.6 |                    |     |        |
|                    |                                 | 2.5 V ± 0.2 V   | 1.7 |                    |     |        |
|                    |                                 | 3.3 V ± 0.3 V   | 1.9 |                    |     |        |



## **Timing Requirements (continued)**

over recommended operating free-air temperature range,  $T_A = -40^{\circ}\text{C}$  to +85°C (unless otherwise noted) (see Figure 3)

|                 |                            |           | V <sub>CC</sub> | MIN | TYP <sup>(1)</sup> | MAX | UNIT |  |  |  |
|-----------------|----------------------------|-----------|-----------------|-----|--------------------|-----|------|--|--|--|
|                 |                            |           | 0.8 V           | 6.7 | 3.4                |     |      |  |  |  |
|                 |                            |           | 1.2 V ± 0.1 V   | 2.4 |                    |     |      |  |  |  |
|                 |                            | Data high | 1.5 V ± 0.1 V   | 1.2 |                    |     |      |  |  |  |
|                 |                            | Data high | 1.8 V ± 0.15 V  | 0.8 |                    |     | ns   |  |  |  |
|                 |                            |           | 2.5 V ± 0.2 V   | 0.6 |                    |     |      |  |  |  |
|                 | Satura time before CLIVA   |           | 3.3 V ± 0.3 V   | 0.4 |                    |     |      |  |  |  |
| t <sub>su</sub> | Setup time before CLK↑     |           | 0.8 V           | 8.9 | 3.4                |     |      |  |  |  |
|                 |                            |           | 1.2 V ± 0.1 V   | 2   |                    |     |      |  |  |  |
|                 |                            | Data low  | 1.5 V ± 0.1 V   | 1.3 |                    |     | ns   |  |  |  |
|                 |                            |           | 1.8 V ± 0.15 V  | 1.1 |                    |     |      |  |  |  |
|                 |                            |           | 2.5 V ± 0.2 V   | 0.8 |                    |     |      |  |  |  |
|                 |                            |           | 3.3 V ± 0.3 V   | 0.7 |                    |     |      |  |  |  |
|                 |                            |           | 0.8 V           | 1   | 0                  |     |      |  |  |  |
|                 |                            |           | 1.2 V ± 0.1 V   | 0   |                    |     |      |  |  |  |
|                 | Hald time added after OUT  |           | 1.5 V ± 0.1 V   | 0   |                    |     |      |  |  |  |
| t <sub>h</sub>  | Hold time, data after CLK↑ |           | 1.8 V ± 0.15 V  | 0   |                    |     | ns   |  |  |  |
|                 |                            |           | 2.5 V ± 0.2 V   | 0   |                    |     |      |  |  |  |
|                 |                            |           |                 | 0   |                    |     |      |  |  |  |

## 6.8 Switching Characteristics: $C_L = 5 pF$

over recommended operating free-air temperature range,  $C_L = 5 \text{ pF}$  (unless otherwise noted) (see Figure 3 and Figure 4)

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT)                   | TEST CO                                       | ONDITIONS   | MIN | TYP  | MAX  | UNIT    |
|------------------|-----------------|----------------------------------|---|---|-----|------|------|---------|
|                  |                 |                                  | V - 0.9 V                                     | T <sub>A</sub> = 25°C                               |     | 91   |      |         |
|                  |                 |                                  | $V_{CC} = 0.8 \text{ V}$                      | $T_A = -40$ °C to +85°C                             | 90  |      |      |         |
|                  |                 |                                  | V 12V 01V                                     | T <sub>A</sub> = 25°C                               |     | 175  |      |         |
|                  |                 |                                  | $V_{CC} = 1.2 \text{ V} \pm 0.1 \text{ V}$    | $T_A = -40$ °C to +85°C                             | 220 |      |      |         |
|                  |                 |                                  | $V_{CC} = 1.5 \text{ V} \pm 0.1 \text{ V}$    | $T_A = 25^{\circ}C$                                 |     | 237  |      |         |
| £                |                 |                                  | V <sub>CC</sub> = 1.5 V ± 0.1 V               | $T_A = -40$ °C to +85°C                             | 230 |      |      | MHz     |
| f <sub>max</sub> |                 |                                  | $V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V}$   | $T_A = 25^{\circ}C$                                 |     | 269  |      | IVII IZ |
|                  |                 | V <sub>CC</sub> = 1.6 V ± 0.15 V | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$ | 240   |     |      |      |         |
|                  |                 |                                  | $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$    | $T_A = 25^{\circ}C$                                 |     | 280  |      | -       |
|                  |                 |                                  | V <sub>CC</sub> = 2.5 V ± 0.2 V               | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$       | 250 |      |      |         |
|                  |                 |                                  | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$    | T <sub>A</sub> = 25°C                               |     | 280  |      |         |
|                  |                 |                                  | V <sub>CC</sub> = 3.3 V ± 0.3 V               | $T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$ | 260 |      |      |         |
|                  |                 |                                  | $V_{CC} = 0.8 \text{ V}$                      | T <sub>A</sub> = 25°C                               |     | 17.2 |      |         |
|                  |                 |                                  | $V_{CC} = 1.2 \text{ V} \pm 0.1 \text{ V}$    | $T_A = 25^{\circ}C$                                 | 3.2 | 7.1  | 14.9 |         |
|                  |                 |                                  | V <sub>CC</sub> = 1.2 V ± 0.1 V               | $T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$ | 2.7 |      | 16.3 |         |
|                  |                 |                                  | $V_{CC} = 1.5 \text{ V} \pm 0.1 \text{ V}$    | $T_A = 25^{\circ}C$                                 | 1.9 | 5    | 9.8  |         |
|                  |                 |                                  | V <sub>CC</sub> = 1.5 V ± 0.1 V               | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$       | 2.1 |      | 10.3 |         |
| $t_{pd}$         | CLK             | Q                                | $V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V}$   | T <sub>A</sub> = 25°C                               | 1.7 | 3.9  | 7.6  | ns      |
|                  |                 |                                  | V <sub>CC</sub> = 1.6 V ± 0.15 V              | $T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$ | 1.6 |      | 8.1  |         |
|                  |                 |                                  | $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$    | T <sub>A</sub> = 25°C                               | 1.4 | 2.8  | 5.3  |         |
|                  |                 |                                  | ACC = 5.9 A ± 0.5 A                           | $T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$ | 1.2 |      | 5.6  |         |
|                  |                 |                                  | V <sub>CC</sub> = 3.3 V ± 0.3 V               | T <sub>A</sub> = 25°C                               | 1.2 | 2.2  | 4.1  |         |
|                  |                 |                                  |   | $T_A = -40$ °C to +85°C                             | 1   |      | 4.4  |         |

Product Folder Links: SN74AUP1G80

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## 6.9 Switching Characteristics: $C_L = 10 pF$

over recommended operating free-air temperature range,  $C_L = 10 \text{ pF}$  (unless otherwise noted) (see Figure 3 and Figure 4)

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT)                              | TEST C                                      | ONDITIONS               | MIN | TYP  | MAX  | UNIT  |
|------------------|-----------------|---|---|-------------------------|-----|------|------|-------|
|                  |                 |   | V <sub>CC</sub> = 0.8 V                     | T <sub>A</sub> = 25°C   |     | 68   |      |       |
|                  |                 |   | V <sub>CC</sub> = 0.8 V                     | $T_A = -40$ °C to +85°C | 70  |      |      |       |
|                  |                 |   | $V_{CC} = 1.2 \text{ V} \pm 0.1 \text{ V}$  | T <sub>A</sub> = 25°C   |     | 128  |      |       |
|                  |                 |   | V <sub>CC</sub> = 1.2 V ± 0.1 V             | $T_A = -40$ °C to +85°C | 170 |      |      |       |
|                  |                 |   | V <sub>CC</sub> = 1.5 V ± 0.1 V             | $T_A = 25$ °C           |     | 189  |      |       |
|                  |                 | V <sub>CC</sub> = 1.5 V ± 0.1 V             | $T_A = -40$ °C to +85°C                     | 220                     |     |      | MHz  |       |
| f <sub>max</sub> |                 |   | $V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V}$ | T <sub>A</sub> = 25°C   |     | 234  |      | IVITZ |
|                  |                 |   | V <sub>CC</sub> = 1.0 V ± 0.13 V            | $T_A = -40$ °C to +85°C | 240 |      |      |       |
|                  |                 |   | $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$  | $T_A = 25$ °C           |     | 273  |      |       |
|                  |                 |   | V <sub>CC</sub> = 2.5 V ± 0.2 V             | $T_A = -40$ °C to +85°C | 250 |      |      |       |
|                  |                 |   | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$  | $T_A = 25$ °C           |     | 280  |      |       |
|                  |                 |   | VCC = 0.0 V ± 0.0 V                         | $T_A = -40$ °C to +85°C | 260 |      |      |       |
|                  |                 |   | V <sub>CC</sub> = 0.8 V                     | T <sub>A</sub> = 25°C   |     | 19.4 |      |       |
|                  |                 |   | $V_{CC} = 1.2 \text{ V} \pm 0.1 \text{ V}$  | $T_A = 25^{\circ}C$     | 4.4 | 8.2  | 16.2 |       |
|                  |                 |   |   | $T_A = -40$ °C to +85°C | 3.4 |      | 17.7 |       |
|                  |                 |   | $V_{CC} = 1.5 \text{ V} \pm 0.1 \text{ V}$  | $T_A = 25$ °C           | 3.6 | 5.8  | 10.7 |       |
|                  |                 |   | VCC = 1.5 V ± 0.1 V                         | $T_A = -40$ °C to +85°C | 2.6 |      | 11.3 |       |
| t <sub>pd</sub>  | CLK Q           | $V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V}$ | $T_A = 25$ °C                               | 2.9                     | 4.6 | 8.4  | ns   |       |
|                  |                 |   | VCC = 1.0 V ± 0.13 V                        | $T_A = -40$ °C to +85°C | 2.1 |      | 3    |       |
|                  |                 | -   | V <sub>CC</sub> = 2.5 V ± 0.2 V             | $T_A = 25$ °C           | 2.2 | 3.3  | 5.9  |       |
|                  |                 |   |   | $T_A = -40$ °C to +85°C | 1.7 |      | 6.3  |       |
|                  |                 |   | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$  | $T_A = 25^{\circ}C$     | 1.9 | 2.7  | 4.7  |       |
|                  |                 |   | vCC = 3.3 v ± 0.3 v                         | $T_A = -40$ °C to +85°C | 1.4 |      | 4.9  |       |

## 6.10 Switching Characteristics: $C_L = 15 pF$

over recommended operating free-air temperature range, C<sub>L</sub> = 15 pF (unless otherwise noted) (see Figure 3 and Figure 4)

| PARAMETER | FROM<br>(INPUT) | TO<br>(OUTPUT)        | TEST C                                     | TEST CONDITIONS MI                            |     |     |   |     |  |
|-----------|-----------------|-----------------------|--|---|-----|-----|---|-----|--|
|           |                 |                       | V 0.0.V                                    | T <sub>A</sub> = 25°C                         |     | 52  |   |     |  |
|           |                 |                       | $V_{CC} = 0.8 \text{ V}$                   | $T_A = -40$ °C to +85°C                       | 50  |     |   |     |  |
|           |                 | $T_{A} = 25^{\circ}C$ | T <sub>A</sub> = 25°C                      |   | 98  |     | Ì |     |  |
|           |                 |                       | $V_{CC} = 1.2 \text{ V} \pm 0.1 \text{ V}$ | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$ | 130 |     |   | Ì   |  |
|           |                 |                       | V 45V 04V                                  | T <sub>A</sub> = 25°C                         |     | 148 |   | MHz |  |
|           |                 |                       | $V_{CC} = 1.5 \text{ V} \pm 0.1 \text{ V}$ | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$ | 180 |     |   |     |  |
| $f_{max}$ |                 |                       | V <sub>CC</sub> = 1.8 V ± 0.15 V           | T <sub>A</sub> = 25°C                         |     | 196 |   |     |  |
|           |                 |                       |  | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$ | 240 |     |   |     |  |
|           |                 |                       | V 05V 00V                                  | T <sub>A</sub> = 25°C                         |     | 249 |   |     |  |
|           |                 |                       | $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$ | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$ | 250 |     |   |     |  |
|           |                 |                       | V <sub>CC</sub> = 3.3 V ± 0.3 V            | T <sub>A</sub> = 25°C                         |     | 280 |   | Ì   |  |
|           |                 |                       |  | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$ | 260 |     |   | İ   |  |



## Switching Characteristics: $C_L = 15 pF$ (continued)

over recommended operating free-air temperature range,  $C_L = 15 \text{ pF}$  (unless otherwise noted) (see Figure 3 and Figure 4)

| PARAMETER       | FROM<br>(INPUT) | TO<br>(OUTPUT)                             | TEST C  | CONDITIONS                                    | MIN | TYP  | MAX  | UNIT |
|-----------------|-----------------|--|---|---|-----|------|------|------|
|                 |                 |  | V <sub>CC</sub> = 0.8 V                       | T <sub>A</sub> = 25°C                         |     | 21.5 |      |      |
|                 |                 |  | V <sub>CC</sub> = 1.2 V ± 0.1 V               | T <sub>A</sub> = 25°C                         | 3   | 9.1  | 17.4 |      |
|                 |                 |  |   | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$ | 4.1 |      | 19   |      |
|                 |                 |  | V 45V 04V                                     | T <sub>A</sub> = 25°C                         | 3.2 | 6.5  | 11.7 |      |
|                 | CLK Q           | $V_{CC} = 1.5 \text{ V} \pm 0.1 \text{ V}$ | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$ | 3.2   |     | 12.3 |      |      |
| t <sub>pd</sub> |                 | Q  | V <sub>CC</sub> = 1.8 V ± 0.15 V              | T <sub>A</sub> = 25°C                         | 2.7 | 4.2  | 9.2  | ns   |
|                 |                 |  |   | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$ | 2.6 |      | 9.8  |      |
|                 |                 |  | V 25V . 02V                                   | T <sub>A</sub> = 25°C                         | 2.2 | 3.8  | 6.5  |      |
|                 |                 |  | $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$    | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$ | 2.1 |      | 6.9  |      |
|                 |                 |  | V <sub>CC</sub> = 3.3 V ± 0.3 V               | T <sub>A</sub> = 25°C                         | 1.9 | 3.1  | 5.1  |      |
|                 |                 |  |   | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$ | 1.8 |      | 5.5  |      |

# **6.11 Switching Characteristics:** C<sub>L</sub> = **30 pF**over recommended operating free-air temperature range. C<sub>L</sub>

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | TEST O                                     | CONDITIONS                                    | MIN | TYP  | MAX  | UNIT  |
|------------------|-----------------|----------------|--|---|-----|------|------|-------|
|                  |                 |                | V -09V                                     | T <sub>A</sub> = 25°C                         |     | 32   |      |       |
|                  |                 |                | $V_{CC} = 0.8 \text{ V}$                   | $T_A = -40$ °C to +85°C                       | 20  |      |      |       |
|                  |                 |                | V <sub>CC</sub> = 1.2 V ± 0.1 V            | $T_A = 25^{\circ}C$                           |     | 71   |      |       |
|                  |                 |                | V <sub>CC</sub> = 1.2 V ± 0.1 V            | $T_A = -40$ °C to +85°C                       | 80  |      |      |       |
|                  |                 |                | $V_{CC} = 1.5 \text{ V} \pm 0.1 \text{ V}$ | $T_A = 25^{\circ}C$                           |     | 104  |      |       |
|                  |                 |                | V <sub>CC</sub> = 1.5 V ± 0.1 V            | $T_A = -40$ °C to +85°C                       | 120 |      |      | MHz   |
| f <sub>max</sub> |                 |                | V <sub>CC</sub> = 1.8 V ± 0.15 V           | $T_A = 25$ °C                                 |     | 133  |      | IVI⊓∠ |
|                  |                 |                | V <sub>CC</sub> = 1.8 V ± 0.15 V           | $T_A = -40$ °C to +85°C                       | 160 |      |      |       |
|                  |                 |                | $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$ | $T_A = 25^{\circ}C$                           |     | 181  |      |       |
|                  |                 |                | V <sub>CC</sub> = 2.5 V ± 0.2 V            | $T_A = -40$ °C to +85°C                       | 220 |      |      |       |
|                  |                 |                | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ | $T_A = 25$ °C                                 |     | 257  |      |       |
|                  |                 |                | V <sub>CC</sub> = 3.3 V ± 0.3 V            | $T_A = -40$ °C to +85°C                       | 260 |      |      |       |
|                  |                 |                | $V_{CC} = 0.8 \text{ V}$                   | $T_A = 25$ °C                                 |     | 28.4 |      |       |
|                  |                 |                | V <sub>CC</sub> = 1.2 V ± 0.1 V            | $T_A = 25^{\circ}C$                           | 5.1 | 11.8 | 20.7 |       |
|                  |                 |                |  | $T_A = -40$ °C to +85°C                       | 6.2 |      | 28.7 |       |
|                  |                 |                | $V_{CC} = 1.5 \text{ V} \pm 0.1 \text{ V}$ | $T_A = 25$ °C                                 | 4.8 | 8.5  | 14.1 | -     |
|                  |                 |                | VCC = 1.5 V ± 0.1 V                        | $T_A = -40$ °C to +85°C                       | 6.9 |      | 16.7 |       |
| t <sub>pd</sub>  | CLK             | Q              | V <sub>CC</sub> = 1.8 V ± 0.15 V           | $T_A = 25$ °C                                 | 4   | 6.9  | 11.2 | ns    |
|                  |                 |                | VCC = 1.0 V ± 0.13 V                       | $T_A = -40$ °C to +85°C                       | 2   |      | 13.3 |       |
|                  |                 |                | $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$ | $T_A = 25$ °C                                 | 3.3 | 5.1  | 7.9  |       |
|                  |                 |                | VCC = 2.3 V ± 0.2 V                        | $T_A = -40$ °C to +85°C                       | 3.2 |      | 9.3  |       |
|                  |                 |                | V <sub>CC</sub> = 3.3 V ± 0.3 V            | $T_A = 25^{\circ}C$                           | 2.9 | 4.2  | 6.4  |       |
|                  |                 |                |  | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$ | 2.8 |      | 7.5  |       |

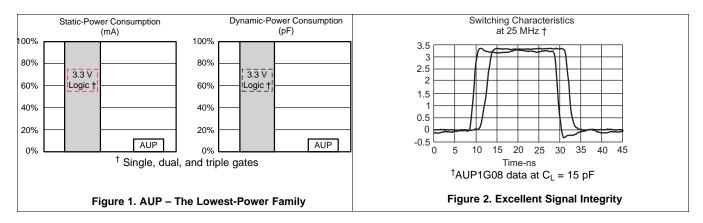


## 6.12 Operating Characteristics

 $T_A = 25^{\circ}C$ 

|   | PARAMETER                     | TEST CONDITIONS | V <sub>cc</sub> | TYP | UNIT |
|---|-------------------------------|-----------------|-----------------|-----|------|
|   |                               |                 | 0.8 V           | 4   | pF   |
|   |                               |                 | 1.2 V ± 0.1 V   | 4   |      |
| 0   | Davis discinsting consitence  | f = 10 MHz      | 1.5 V ± 0.1 V   | 4   |      |
| C <sub>pd</sub> Power dissipation capacitance | Power dissipation capacitance |                 | 1.8 V ± 0.15 V  | 4   |      |
|   |                               |                 | 2.5 V ± 0.2 V   | 4.1 |      |
|   |                               |                 | 3.3 V ± 0.3 V   | 4.3 |      |

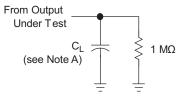
## 6.13 Typical Characteristics





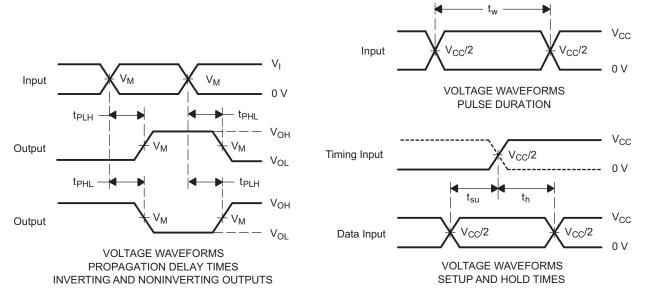
## 7 Parameter Measurement Information

## 7.1 Propagation Delays, Setup and Hold Times, and Pulse Duration



LOAD CIRCUIT

|                | V <sub>CC</sub> = 0.8 V | V <sub>CC</sub> = 1.2 V<br>± 0.1 V | V <sub>CC</sub> = 1.5 V<br>± 0.1 V | $V_{CC} = 1.8 V$<br>± 0.15 V | $V_{CC} = 2.5 V$<br>$\pm 0.2 V$ | V <sub>CC</sub> = 3.3 V<br>± 0.3 V |
|----------------|-------------------------|------------------------------------|------------------------------------|------------------------------|---------------------------------|------------------------------------|
| C <sub>L</sub> | 5, 10, 15, 30 pF        | 5, 10, 15, 30 pF                   | 5, 10, 15, 30 pF                   | 5, 10, 15, 30 pF             | 5, 10, 15, 30 pF                | 5, 10, 15, 30 pF                   |
| V <sub>M</sub> | V <sub>CC</sub> /2      | V <sub>CC</sub> /2                 | V <sub>CC</sub> /2                 | V <sub>CC</sub> /2           | V <sub>CC</sub> /2              | V <sub>CC</sub> /2                 |
| V <sub>I</sub> | V <sub>CC</sub>         | V <sub>CC</sub>                    | V <sub>CC</sub>                    | V <sub>CC</sub>              | V <sub>CC</sub>                 | V <sub>CC</sub>                    |



NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

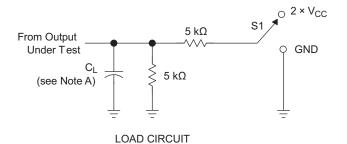
- B. All input pulses are supplied by generators having the following characteristics: PRR $\leq$  10 MHz,  $Z_O$  = 50  $\Omega$ ,  $t_r/t_f$  = 3 ns.
- C. The outputs are measured one at a time, with one transition per measurement.
- D.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{od}$ .
- E. All parameters and waveforms are not applicable to all devices.

Figure 3. Load Circuit and Voltage Waveforms

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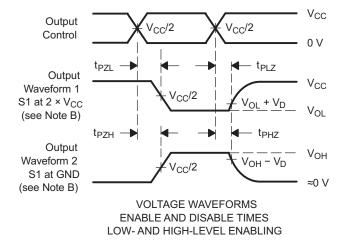


### 7.2 Enable and Disable Times



| TEST                               | S1                  |
|------------------------------------|---------------------|
| t <sub>PLZ</sub> /t <sub>PZL</sub> | 2 × V <sub>CC</sub> |
| t <sub>PHZ</sub> /t <sub>PZH</sub> | GND                 |

 $V_{CC} = 1.2 \text{ V}$  $V_{CC} = 1.5 V$  $V_{CC} = 1.8 \text{ V}$  $V_{CC} = 2.5 V$  $V_{CC} = 3.3 \text{ V}$  $V_{CC} = 0.8 \text{ V}$ ± 0.1 V ± 0.1 V ± 0.15 V ± 0.2 V ± 0.3 V 5, 10, 15, 30 pF  $C_L$  $V_{M}$ V<sub>CC</sub>/2 V<sub>CC</sub>/2  $V_{CC}/2$  $V_{CC}/2$  $V_{CC}/2$  $V_{CC}/2$  $V_{\text{CC}}$  $V_{\text{CC}}$  $V_{I}$  $V_{CC}$  $V_{CC}$  $V_{CC}$  $V_{CC}$ 0.1 V 0.1 V 0.1 V 0.15 V 0.15 V 0.3 V  $V_{D}$ 



NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR≤ 10 MHz, Z<sub>Ω</sub> = 50 Ω, t<sub>t</sub>/t<sub>f</sub> = 3 ns.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. t<sub>PLZ</sub> and t<sub>PHZ</sub> are the same as t<sub>dis</sub>.
- F. t<sub>PZL</sub> and t<sub>PZH</sub> are the same as t<sub>en</sub>.
- G. All parameters and waveforms are not applicable to all devices.

Figure 4. Load Circuit and Voltage Waveforms

## 8 Detailed Description

#### 8.1 Overview

The SN74AUP1G80 is a single positive-edge-triggered D-type flip-flop. Data at the input (D) is transferred to the output  $\overline{(Q)}$  on the positive-going edge of the clock pulse when the setup time requirement is met. Because the clock triggering occurs at a voltage level, it is not directly related to the rise time of the clock pulse. This allows for data at the input to be changed without affecting the level at the output, following the hold-time interval.

## 8.2 Functional Block Diagram

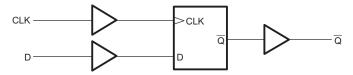


Figure 5. Logic Diagram (Positive Logic)

## 8.3 Feature Description

### 8.3.1 Balanced CMOS Push-Pull Outputs

A balanced output allows the device to sink and source similar currents. The drive capability of this device may create fast edges into light loads so routing and load conditions should be considered to prevent ringing. Additionally, the outputs of this device are capable of driving larger currents than the device can sustain without being damaged. It is important for the power output of the device to be limited to avoid damage due to overcurrent. The electrical and thermal limits defined the in the *Absolute Maximum Ratings* table must be followed at all times.

#### 8.3.2 Standard CMOS Inputs

Standard CMOS inputs are high impedance and are typically modeled as a resistor in parallel with the input capacitance given in the *Electrical Characteristics:*  $T_A = 25^{\circ}\text{C}$  table. The worst case resistance is calculated with the maximum input voltage, given in the *Absolute Maximum Ratings* table, and the maximum input leakage current, given in the *Electrical Characteristics:*  $T_A = 25^{\circ}\text{C}$  table, using ohm's law (R = V ÷ I).

Signals applied to the inputs need to have fast edge rates, as defined by  $\Delta t/\Delta v$  in *Recommended Operating Conditions* table to avoid excessive currents and oscillations. If a slow or noisy input signal is required, a device with a Schmitt-trigger input should be used to condition the input signal prior to the standard CMOS input.

#### 8.3.3 Clamp Diodes

The inputs and outputs to this device have negative clamping diodes.

## **CAUTION**

Voltages beyond the values specified in the *Absolute Maximum Ratings* table can cause damage to the device. The input negative-voltage and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

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## **Feature Description (continued)**

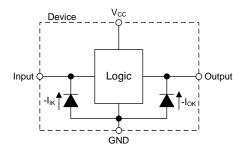


Figure 6. Electrical Placement of Clamping Diodes for Each Input and Output

## 8.3.4 Partial Power Down (Ioff)

The inputs and outputs for this device enter a high-impedance state when the supply voltage is 0 V. The maximum leakage into or out of any input or output pin on the device is specified by  $I_{off}$  in the *Electrical Characteristics:*  $T_A = 25^{\circ}C$  table.

## 8.3.5 Over-Voltage Tolerant Inputs

Input signals to this device can be driven above the supply voltage so long as they remain below the maximum input voltage value specified in the *Absolute Maximum Ratings* table.

### 8.4 Device Functional Modes

Table 1 lists the functional modes of the SN74AUP1G80 device.

**Table 1. Function Table** 

| INPU     | INPUTS |                  |  |  |  |
|----------|--------|------------------|--|--|--|
| CLK      | Q      |                  |  |  |  |
| 1        | Н      | L                |  |  |  |
| <b>↑</b> | L      | Н                |  |  |  |
| L or H   | Χ      | $\overline{Q}_0$ |  |  |  |



## 9 Application and Implementation

#### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

## 9.1 Application Information

A useful application for the SN74AUP1G80 is using it as a frequency divider. By feeding back the output  $(\overline{Q})$  to the input (D), the output toggles on every rising edge of the clock waveform. The output goes HIGH once every two clock cycles, so essentially the frequency of the clock signal is divided by a factor of two. The device does not have preset or clear functions so the initial state of the output is unknown. This application implements the use of an override pin to initially set the input HIGH or LOW. Initialization is not needed, but should be kept in mind. Post initialization, the Override input is set to a high-impedance mode, or it can be used to force a HIGH or LOW output.

## 9.2 Typical Application

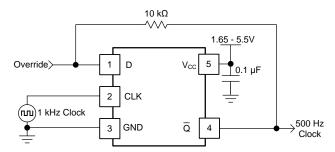


Figure 7. Clock Frequency Division

### 9.2.1 Design Requirements

For this application, a resistor must be placed on the feedback line in order for the initialization voltage from the override input to overpower the signal coming from the output  $(\overline{Q})$ . Without a resistor the state at the input would be unknown as the output of the SN74AUP1G80 is driving the line separate from the Override input.

The SN74AUP1G80 device uses CMOS technology and has balanced output drive. Take care to avoid bus contention because it can drive currents that would exceed maximum limits.

### 9.2.2 Detailed Design Procedure

- 1. Recommended input conditions:
  - For rise time and fall time specifications, see  $\Delta t/\Delta v$  in the *Recommended Operating Conditions* table.
  - For specified high and low levels, see V<sub>IH</sub> and V<sub>IL</sub> in the *Recommended Operating Conditions* table.
  - Input voltages are recommended to not go below 0 V and not exceed 4.6 V for any V<sub>CC</sub>. See the Absolute
     Maximum Ratings table.

### 2. Recommended output conditions:

- Load currents should not exceed ±20 mA. See the Absolute Maximum Ratings table.
- Output voltages are recommended to not go below 0 V and not exceed the V<sub>CC</sub> voltage. See the Absolute
   Maximum Ratings table.

## 3. Feedback resistor:

– A 10-kΩ resistor is chosen to bias the input so the Override input can initialize the input and output. The resistor value is important because a resistance too high, such as 1 MΩ, would cause too much of a voltage drop, causing the output to no longer be able to drive the input. On the other hand, a resistor too low, such as a 1  $\Omega$ , would not bias enough and might cause bus contention between the  $\overline{\mathbb{Q}}$  output and the override input, possibly damaging the device.

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## **Typical Application (continued)**

### 9.2.3 Application Curve

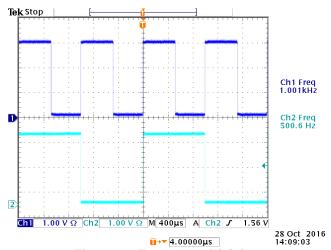


Figure 8. Frequency Division

## 10 Power Supply Recommendations

The power supply can be any voltage between the minimum and maximum supply voltage rating listed in the Recommended Operating Conditions table. A 0.1-µF bypass capacitor is recommended to be connected from the VCC terminal to GND to prevent power disturbance. To reject different frequencies of noise, use multiple bypass capacitors in parallel. Capacitors with values of 0.1 µF and 1 µF are commonly used in parallel. The bypass capacitor must be installed as close to the power terminal as possible for best results.

#### Layout 11

## 11.1 Layout Guidelines

When a printed-circuit board (PCB) trace turns a corner at a 90° angle, a reflection can occur. A reflection occurs primarily because of the change of width of the trace. At the apex of the turn, the trace width increases to 1.414 times the width. This increase upsets the transmission-line characteristics, especially the distributed capacitance and self-inductance of the trace which results in the reflection. Not all PCB traces can be straight and therefore some traces must turn corners. Figure 9 shows progressively better techniques of rounding corners. Only the last example (BEST) maintains constant trace width and minimizes reflections.

## 11.2 Layout Example

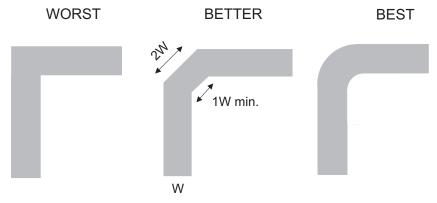


Figure 9. Trace Example

Product Folder Links: SN74AUP1G80

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## 12 Device and Documentation Support

## 12.1 Documentation Support

#### 12.1.1 Related Documentation

For related documentation see the following:

- Implications of Slow or Floating CMOS Inputs
- Designing and Manufacturing with TI's X2SON Packages
- How to Select Little Logic
- Introduction to Logic
- Power-Up Behavior of Clocked Devices
- Understanding Schmitt Triggers
- Semiconductor Packing Material Electrostatic Discharge (ESD) Protection

## 12.2 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

## 12.3 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

TI E2E™ Online Community TI's Engineer-to-Engineer (E2E) Community. Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

**Design Support** *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

#### 12.4 Trademarks

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### 12.5 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

## 12.6 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

## 13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

www.ti.com 1-May-2025

#### PACKAGING INFORMATION

| Orderable part number | Status | Material type | Package   Pins   | Package qty   Carrier | <b>RoHS</b> (3) | Lead finish/<br>Ball material | MSL rating/<br>Peak reflow | Op temp (°C) | Part marking (6)              |
|-----------------------|--------|---------------|------------------|-----------------------|-----------------|-------------------------------|----------------------------|--------------|-------------------------------|
| SN74AUP1G80DBVR       | Active | Production    | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes             | NIPDAU                        | Level-1-260C-UNLIM         | -40 to 85    | H80R                          |
| SN74AUP1G80DBVT       | Active | Production    | SOT-23 (DBV)   5 | 250   SMALL T&R       | Yes             | NIPDAU                        | Level-1-260C-UNLIM         | -40 to 85    | H80R                          |
| SN74AUP1G80DCKR       | Active | Production    | SC70 (DCK)   5   | 3000   LARGE T&R      | Yes             | NIPDAU   NIPDAU               | Level-1-260C-UNLIM         | -40 to 85    | (HX5, HXF, HXK, HX<br>O, HXR) |
| SN74AUP1G80DCKRG4     | Active | Production    | SC70 (DCK)   5   | 3000   LARGE T&R      | Yes             | NIPDAU                        | Level-1-260C-UNLIM         | -40 to 85    | (HX5, HXF, HXK, HX<br>O, HXR) |
| SN74AUP1G80DCKT       | Active | Production    | SC70 (DCK)   5   | 250   SMALL T&R       | Yes             | NIPDAU   NIPDAU               | Level-1-260C-UNLIM         | -40 to 85    | (HX5, HXO, HXR)               |
| SN74AUP1G80DPWR       | Active | Production    | X2SON (DPW)   5  | 3000   LARGE T&R      | Yes             | NIPDAU   NIPDAU               | Level-1-260C-UNLIM         | -40 to 85    | (B, BC)                       |
| SN74AUP1G80DRYR       | Active | Production    | SON (DRY)   6    | 5000   LARGE T&R      | Yes             | NIPDAU   NIPDAUAG             | Level-1-260C-UNLIM         | -40 to 85    | HX                            |
| SN74AUP1G80DSFR       | Active | Production    | SON (DSF)   6    | 5000   LARGE T&R      | Yes             | NIPDAU   NIPDAUAG<br>  NIPDAU | Level-1-260C-UNLIM         | -40 to 85    | НХ                            |
| SN74AUP1G80YFPR       | Active | Production    | DSBGA (YFP)   6  | 3000   LARGE T&R      | Yes             | SNAGCU                        | Level-1-260C-UNLIM         | -            | HXN                           |

<sup>(1)</sup> Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

<sup>(2)</sup> Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

<sup>(4)</sup> Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.



## **PACKAGE OPTION ADDENDUM**

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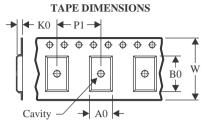
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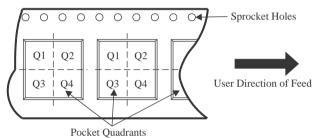
## TAPE AND REEL INFORMATION





| A0 | Dimension designed to accommodate the component width     |
|----|---|
| В0 | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

## QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

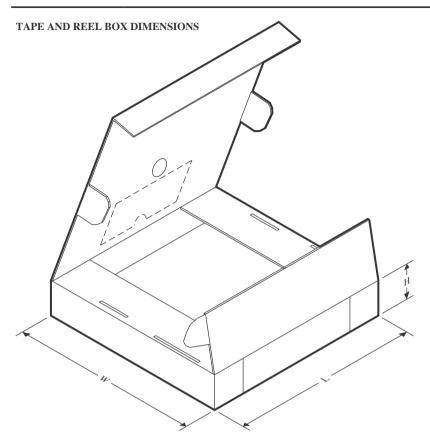


#### \*All dimensions are nominal

| Device            | Package<br>Type | Package<br>Drawing |   | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|-------------------|-----------------|--------------------|---|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| SN74AUP1G80DBVR   | SOT-23          | DBV                | 5 | 3000 | 180.0                    | 8.4                      | 3.23       | 3.17       | 1.37       | 4.0        | 8.0       | Q3               |
| SN74AUP1G80DBVT   | SOT-23          | DBV                | 5 | 250  | 180.0                    | 8.4                      | 3.23       | 3.17       | 1.37       | 4.0        | 8.0       | Q3               |
| SN74AUP1G80DCKR   | SC70            | DCK                | 5 | 3000 | 179.0                    | 8.4                      | 2.2        | 2.5        | 1.2        | 4.0        | 8.0       | Q3               |
| SN74AUP1G80DCKR   | SC70            | DCK                | 5 | 3000 | 178.0                    | 9.2                      | 2.4        | 2.4        | 1.22       | 4.0        | 8.0       | Q3               |
| SN74AUP1G80DCKRG4 | SC70            | DCK                | 5 | 3000 | 178.0                    | 9.2                      | 2.4        | 2.4        | 1.22       | 4.0        | 8.0       | Q3               |
| SN74AUP1G80DCKT   | SC70            | DCK                | 5 | 250  | 180.0                    | 8.4                      | 2.47       | 2.3        | 1.25       | 4.0        | 8.0       | Q3               |
| SN74AUP1G80DCKT   | SC70            | DCK                | 5 | 250  | 178.0                    | 9.2                      | 2.4        | 2.4        | 1.22       | 4.0        | 8.0       | Q3               |
| SN74AUP1G80DCKT   | SC70            | DCK                | 5 | 250  | 179.0                    | 8.4                      | 2.2        | 2.5        | 1.2        | 4.0        | 8.0       | Q3               |
| SN74AUP1G80DPWR   | X2SON           | DPW                | 5 | 3000 | 180.0                    | 8.4                      | 0.91       | 0.91       | 0.5        | 2.0        | 8.0       | Q3               |
| SN74AUP1G80DRYR   | SON             | DRY                | 6 | 5000 | 180.0                    | 8.4                      | 1.25       | 1.6        | 0.7        | 4.0        | 8.0       | Q1               |
| SN74AUP1G80DRYR   | SON             | DRY                | 6 | 5000 | 180.0                    | 9.5                      | 1.15       | 1.6        | 0.75       | 4.0        | 8.0       | Q1               |
| SN74AUP1G80DSFR   | SON             | DSF                | 6 | 5000 | 180.0                    | 8.4                      | 1.16       | 1.16       | 0.5        | 4.0        | 8.0       | Q2               |
| SN74AUP1G80YFPR   | DSBGA           | YFP                | 6 | 3000 | 178.0                    | 9.2                      | 0.89       | 1.29       | 0.62       | 4.0        | 8.0       | Q1               |



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\*All dimensions are nominal

| Device            | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74AUP1G80DBVR   | SOT-23       | DBV             | 5    | 3000 | 202.0       | 201.0      | 28.0        |
| SN74AUP1G80DBVT   | SOT-23       | DBV             | 5    | 250  | 202.0       | 201.0      | 28.0        |
| SN74AUP1G80DCKR   | SC70         | DCK             | 5    | 3000 | 200.0       | 183.0      | 25.0        |
| SN74AUP1G80DCKR   | SC70         | DCK             | 5    | 3000 | 180.0       | 180.0      | 18.0        |
| SN74AUP1G80DCKRG4 | SC70         | DCK             | 5    | 3000 | 180.0       | 180.0      | 18.0        |
| SN74AUP1G80DCKT   | SC70         | DCK             | 5    | 250  | 202.0       | 201.0      | 28.0        |
| SN74AUP1G80DCKT   | SC70         | DCK             | 5    | 250  | 180.0       | 180.0      | 18.0        |
| SN74AUP1G80DCKT   | SC70         | DCK             | 5    | 250  | 203.0       | 203.0      | 35.0        |
| SN74AUP1G80DPWR   | X2SON        | DPW             | 5    | 3000 | 210.0       | 185.0      | 35.0        |
| SN74AUP1G80DRYR   | SON          | DRY             | 6    | 5000 | 183.0       | 183.0      | 20.0        |
| SN74AUP1G80DRYR   | SON          | DRY             | 6    | 5000 | 184.0       | 184.0      | 19.0        |
| SN74AUP1G80DSFR   | SON          | DSF             | 6    | 5000 | 210.0       | 185.0      | 35.0        |
| SN74AUP1G80YFPR   | DSBGA        | YFP             | 6    | 3000 | 220.0       | 220.0      | 35.0        |

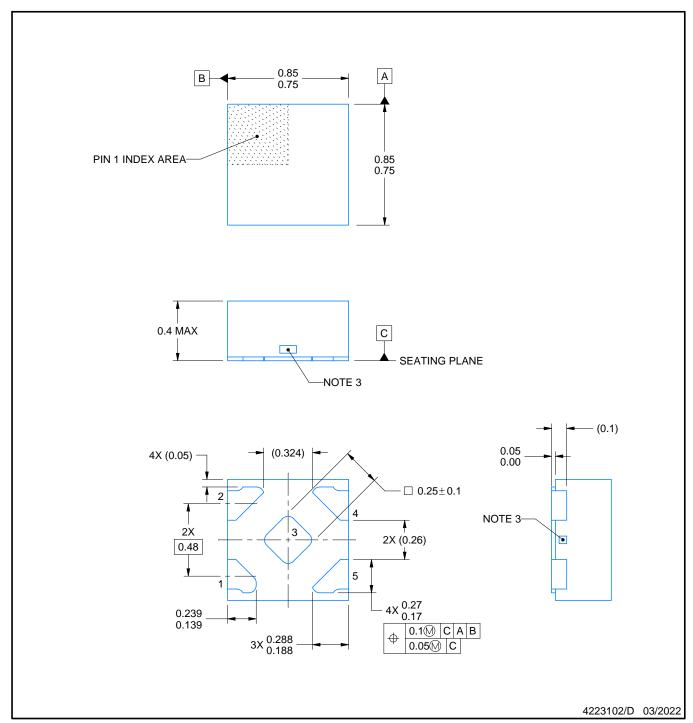


Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.

4211218-3/D





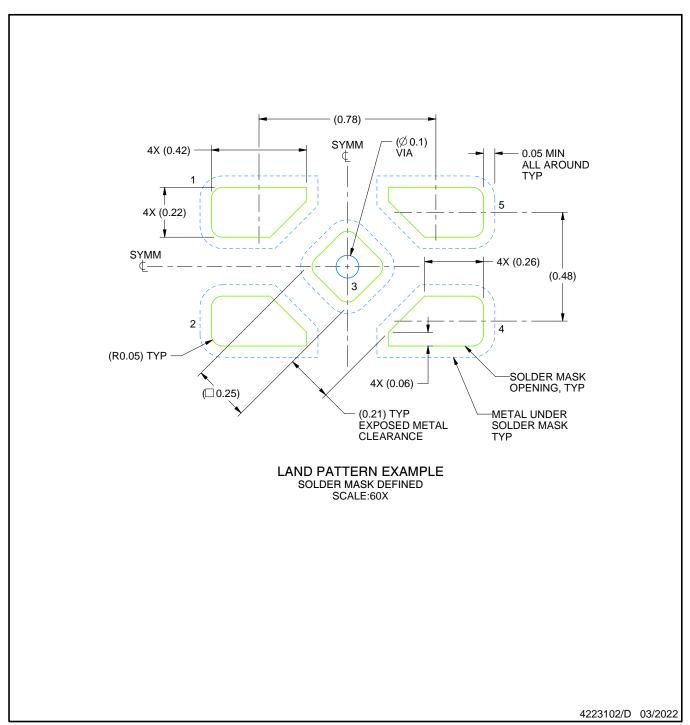


### NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.
- 3. The size and shape of this feature may vary.

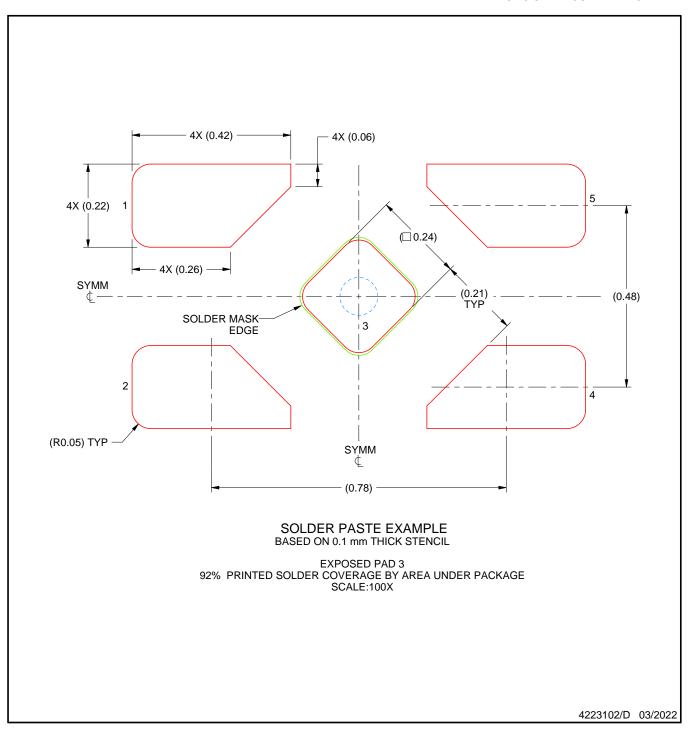




NOTES: (continued)

4. This package is designed to be soldered to a thermal pad on the board. For more information, refer to QFN/SON PCB application note in literature No. SLUA271 (www.ti.com/lit/slua271).





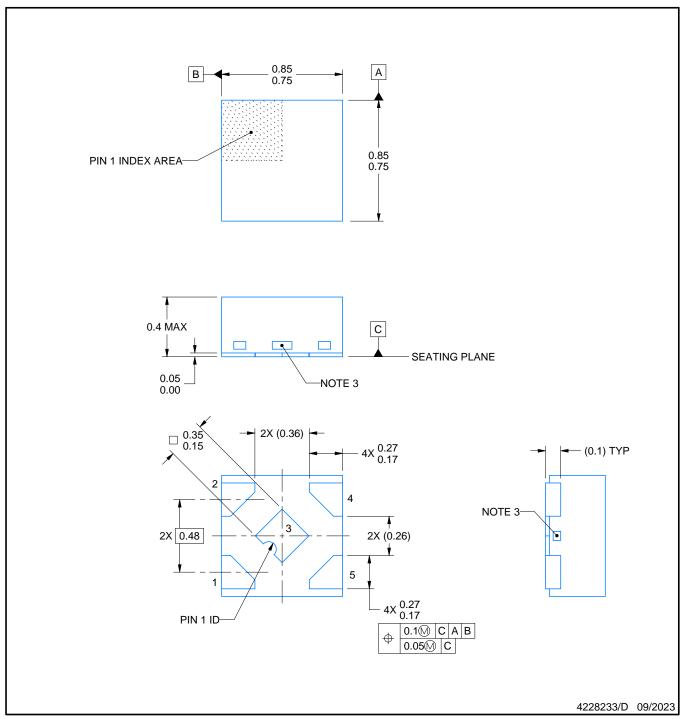
NOTES: (continued)

5. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



## X2SON - 0.4 mm max height

PLASTIC SMALL OUTLINE - NO LEAD

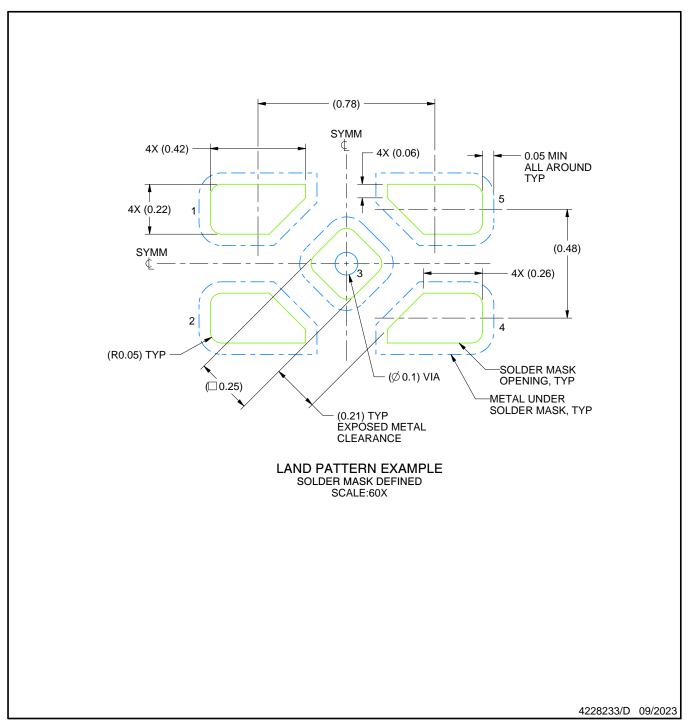


### NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.
- 3. The size and shape of this feature may vary.

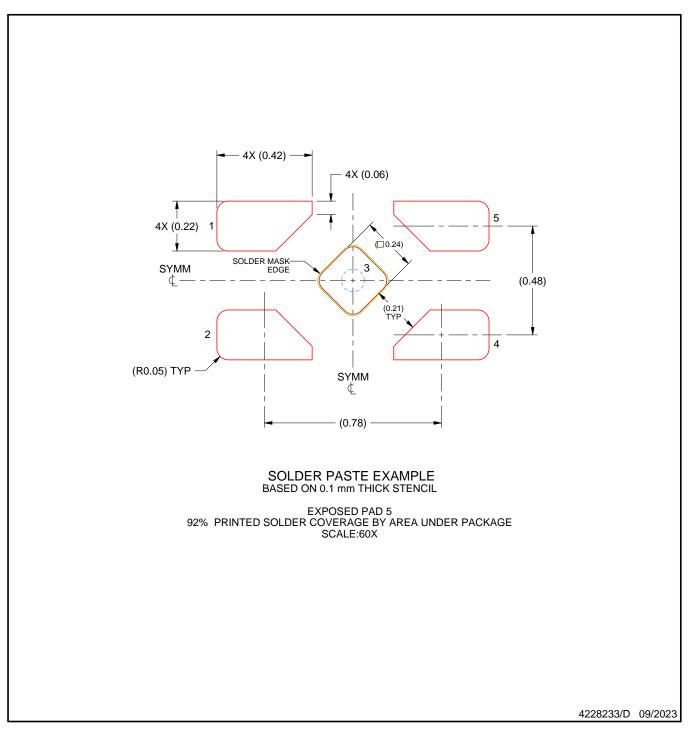




NOTES: (continued)

4. This package is designed to be soldered to a thermal pad on the board. For more information, refer to QFN/SON PCB application note in literature No. SLUA271 (www.ti.com/lit/slua271).





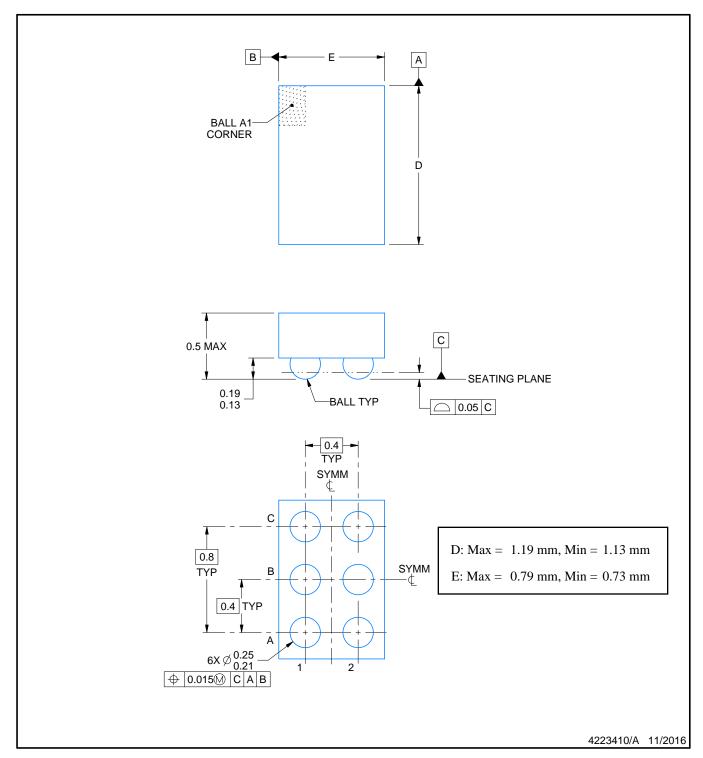
NOTES: (continued)

5. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.





DIE SIZE BALL GRID ARRAY

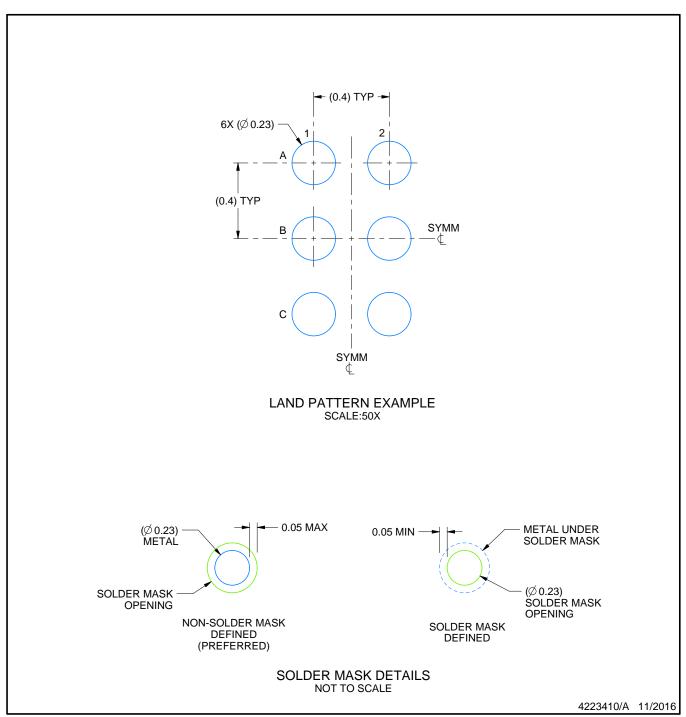


## NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
  2. This drawing is subject to change without notice.



DIE SIZE BALL GRID ARRAY

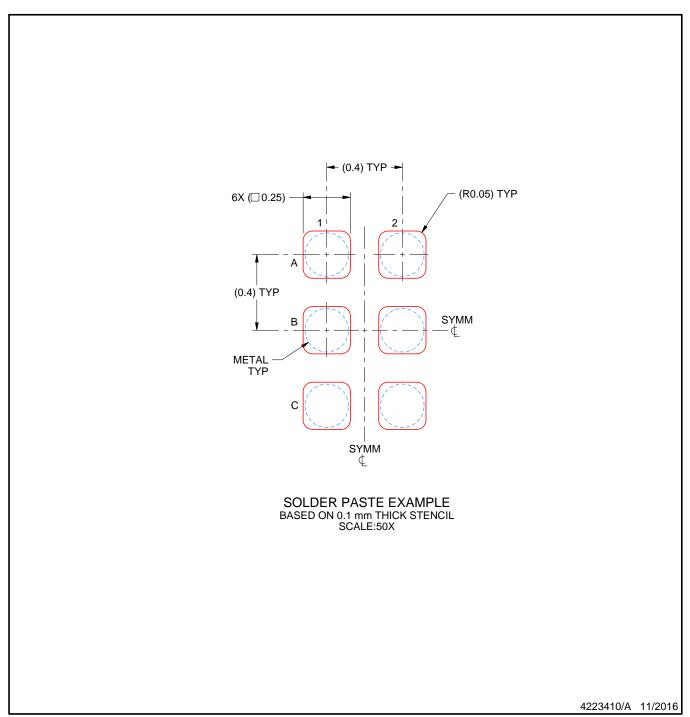


NOTES: (continued)

3. Final dimensions may vary due to manufacturing tolerance considerations and also routing constraints. For more information, see Texas Instruments literature number SNVA009 (www.ti.com/lit/snva009).



DIE SIZE BALL GRID ARRAY

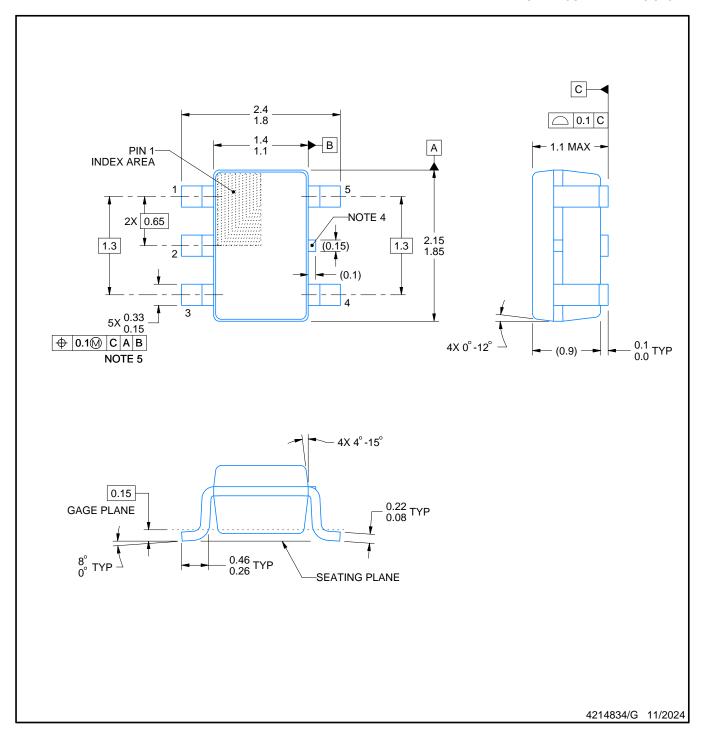


NOTES: (continued)

4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release.





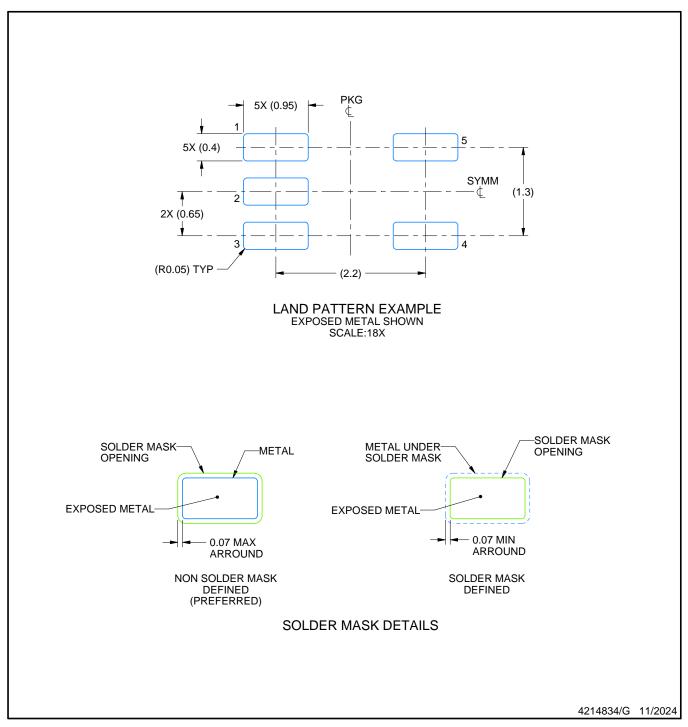


## NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
  2. This drawing is subject to change without notice.
  3. Reference JEDEC MO-203.

- 4. Support pin may differ or may not be present.5. Lead width does not comply with JEDEC.
- 6. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25mm per side

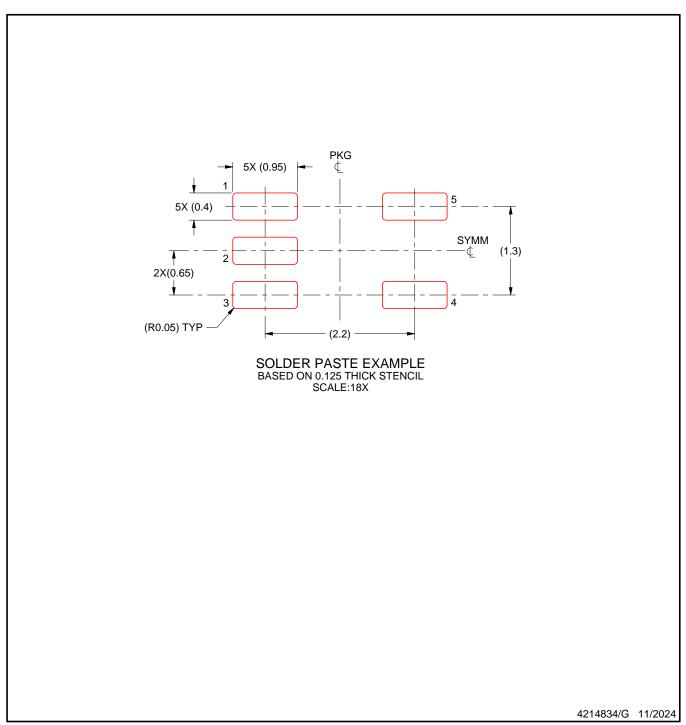




NOTES: (continued)

7. Publication IPC-7351 may have alternate designs.8. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



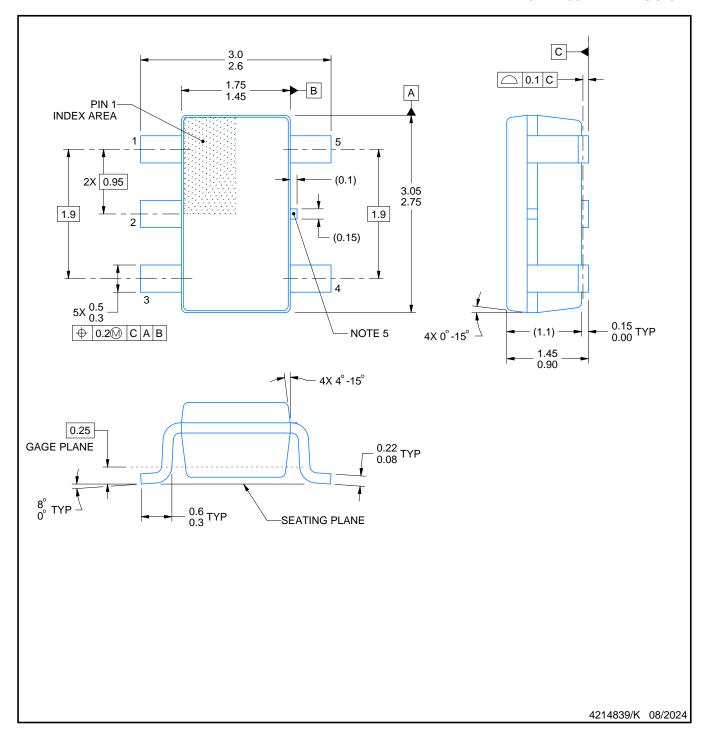


NOTES: (continued)

- 9. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 10. Board assembly site may have different recommendations for stencil design.





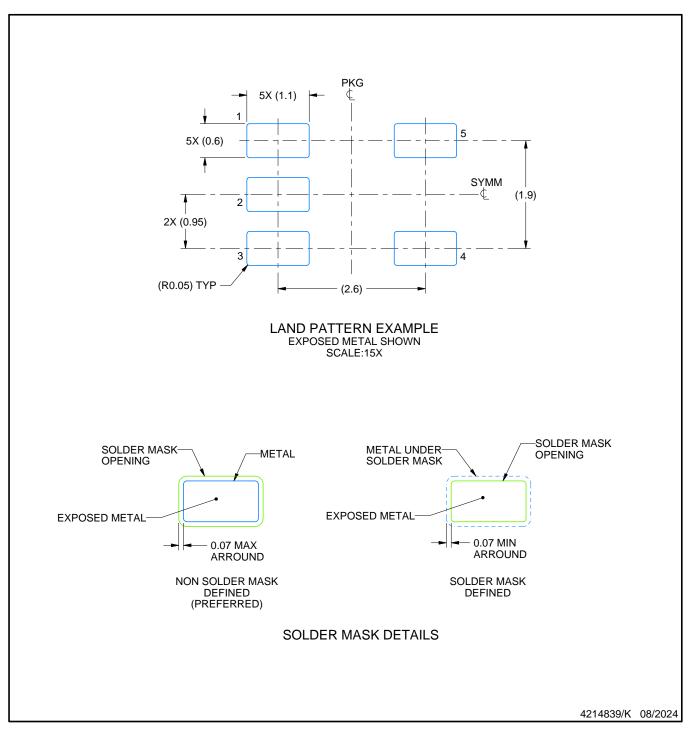


## NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
  2. This drawing is subject to change without notice.
  3. Reference JEDEC MO-178.

- 4. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25 mm per side.
- 5. Support pin may differ or may not be present.



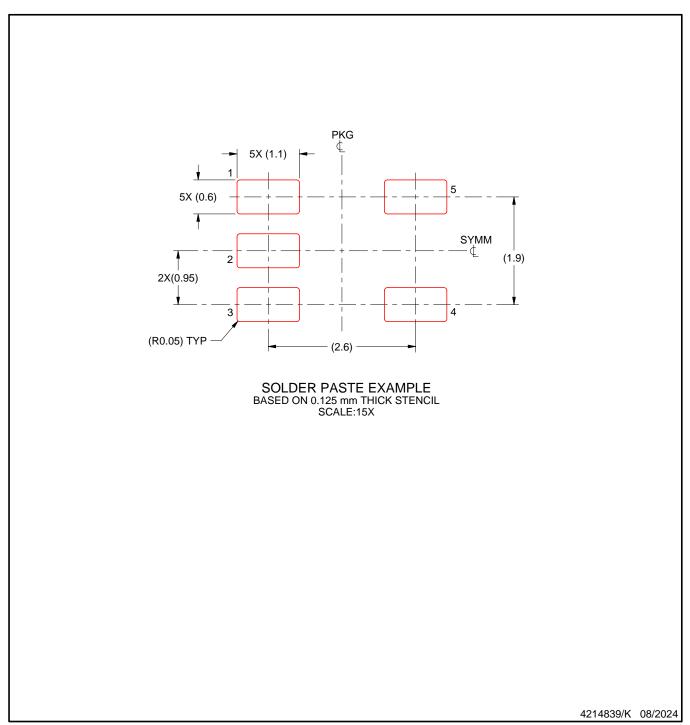


NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.





NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



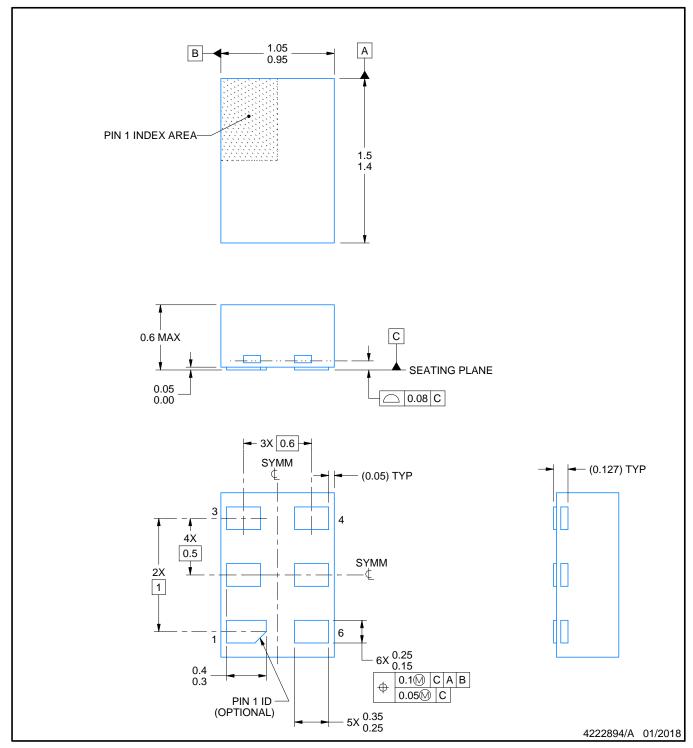


Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.







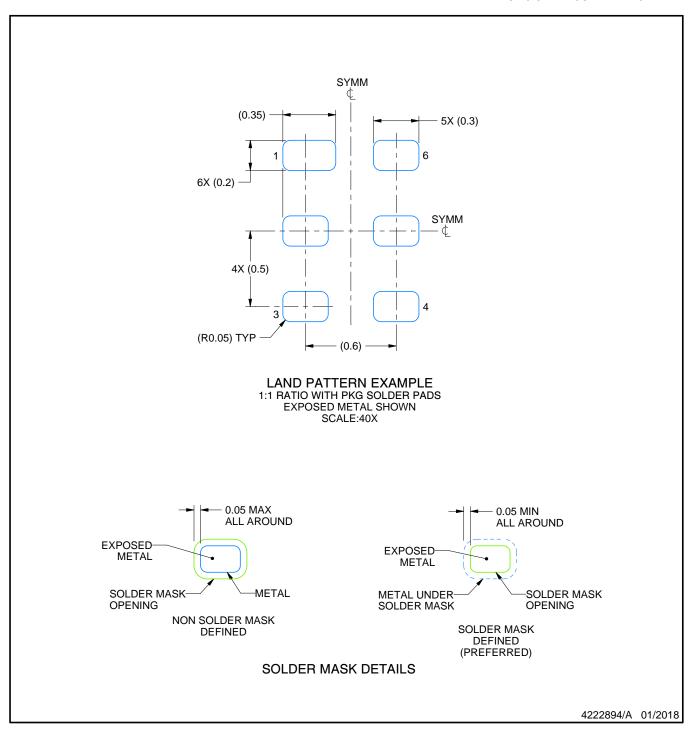


### NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

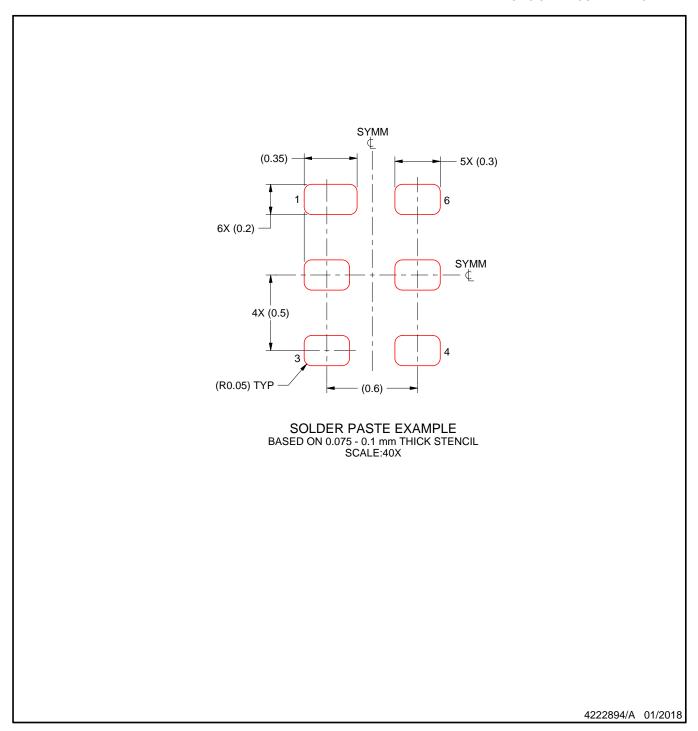




NOTES: (continued)

3. For more information, see QFN/SON PCB application report in literature No. SLUA271 (www.ti.com/lit/slua271).



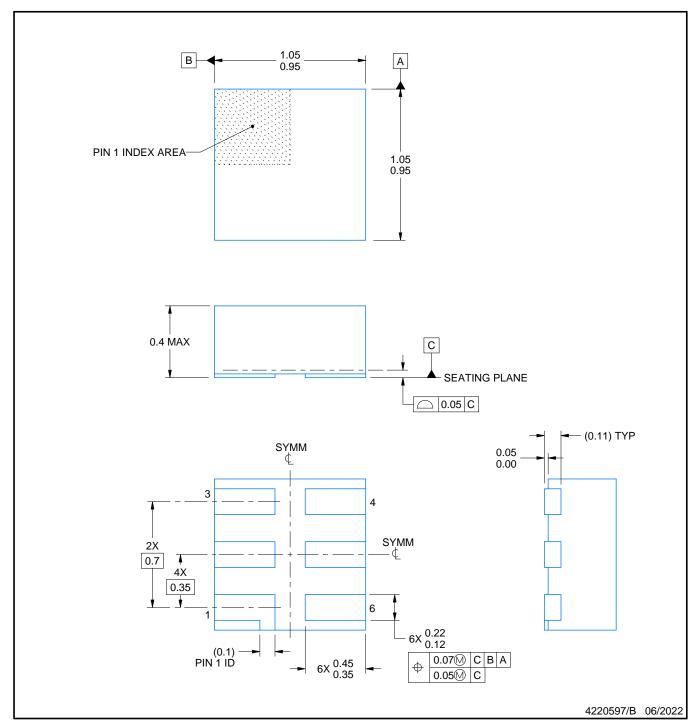


NOTES: (continued)

Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.







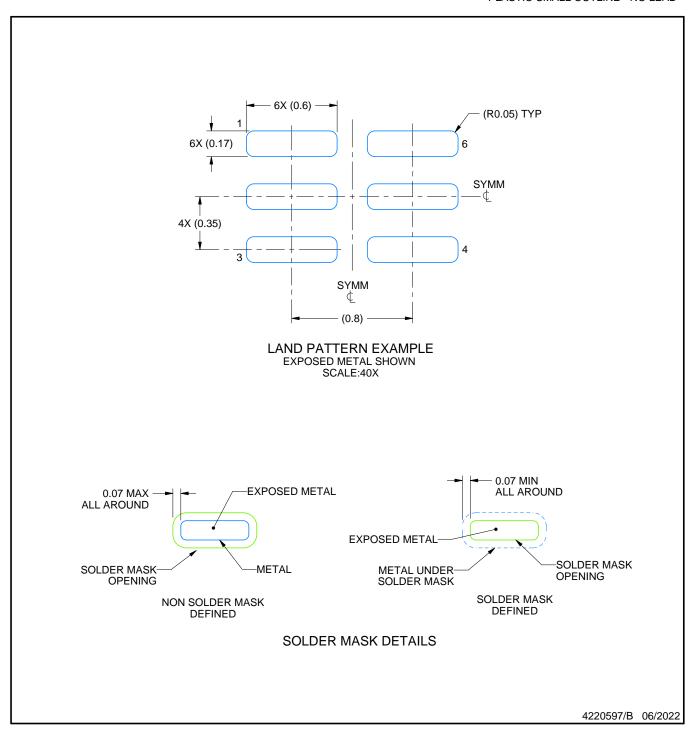
## NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. Reference JEDEC registration MO-287, variation X2AAF.

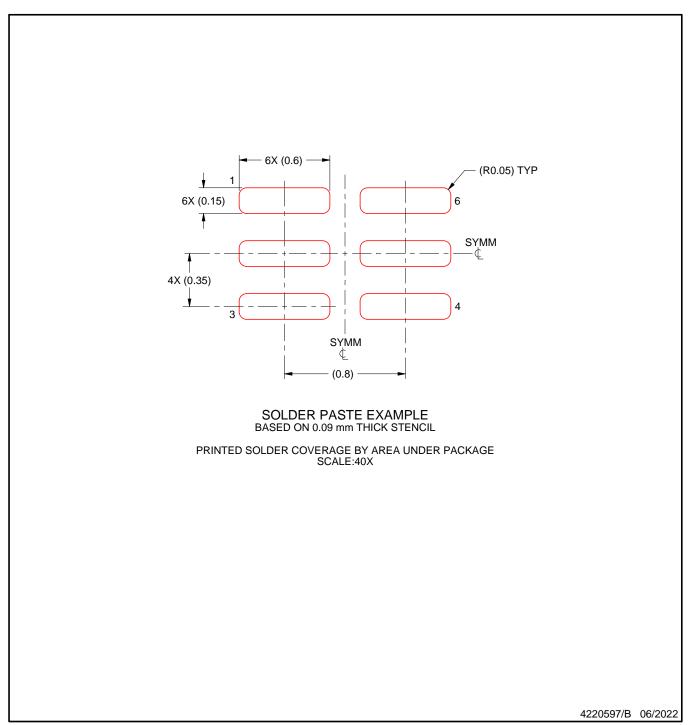




NOTES: (continued)

4. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).





4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



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